



N-Channel 60-V (D-S) MOSFET

| PRODUCT SUMMARY | | | | | |
|---------------------|---|------|--|--|--|
| V _{DS} (V) | $R_{DS(on)}\left(\Omega\right)$ $I_{D}\left(A\right)$ | | | | |
| 60 | 0.011 at V _{GS} = 10 V | 12.7 | | | |
| | 0.013 at V _{GS} = 6.0 V | 11.7 | | | |

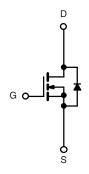
FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFETs
- 175 °C Maximum Junction Temperature
- Compliant to RoHS Directive 2002/95/EC



APPLICATIONS

· Primary Side Switch



N-Channel MOSFET

| | · | SO-8 | | |
|---|---|------|---|---|
| S | 1 | | 8 | D |
| S | 2 | | 7 | D |
| S | 3 | | 6 | D |
| G | 4 | | 5 | D |
| | | | • | |

Top View **Ordering Information:** Si4470EY-T1-E3 (Lead (Pb)-free)

Si4470EY-T1-GE3 (Lead (Pb)-free and Halogen-free)

| ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted | | | | | | |
|--|------------------------|-----------------------------------|-------------|--------------|------|--|
| Parameter | | Symbol | 10 s | Steady State | Unit | |
| Drain-Source Voltage | | V _{DS} | 60 | | V | |
| Gate-Source Voltage | | V _{GS} | ± 20 | | V | |
| Continuous Dusin Comment /T. 150 90V8 | T _A = 25 °C | 1 | 12.7 | 9.0 | | |
| Continuous Drain Current (T _J = 150 °C) ^a | T _A = 70 °C | - I _D | 10.6 | 7.5 | | |
| Pulsed Drain Current | | I _{DM} | 50 | | Α | |
| Avalanche Current | L = 0.1 mH | I _{AS} | 50 | | | |
| Continuous Source Current (Diode Conduction) ^a | | I _S | 3.1 | 1.5 | | |
| Manipus Barra Brain diag | T _A = 25 °C | P _D | 3.75 | 1.85 | W | |
| Maximum Power Dissipation ^a | T _A = 70 °C | I D | 2.6 | 1.3 | V V | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stq} | - 55 to 175 | | °C | |

| THERMAL RESISTANCE RATINGS | | | | | |
|--|--------------|-------------------|---------|---------|------|
| Parameter | | Symbol | Typical | Maximum | Unit |
| Mariana haratina ta Analianta | t ≤ 10 s | R _{thJA} | 33 | 40 | |
| Maximum Junction-to-Ambient ^a | Steady State | ' 'thJA | 65 | 80 | °C/W |
| Maximum Junction-to-Foot (Drain) | Steady State | R _{thJF} | 17 | 21 | |

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

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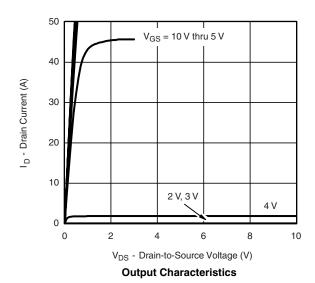
| SPECIFICATIONS T _J = 25 °C, unless otherwise noted | | | | | | | | |
|--|---------------------|--|------|-------------|-------|------|--|--|
| Parameter | Symbol | Test Conditions Min. | | Тур. | Max. | Unit | | |
| Static | | | | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$ | 2.0 | | | V | | |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | | | ± 100 | nA | | |
| Zara Cata Valtana Duain Comunit | 1 | V _{DS} = 48 V, V _{GS} = 0 V V _{DS} = 48 V, V _{GS} = 0 V, T _J = 55 °C | | | 1 | μΑ | | |
| Zero Gate Voltage Drain Current | I _{DSS} | | | | 5 | | | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$ | 50 | | | Α | | |
| Drain-Source On-State Resistance ^a | В | V _{GS} = 10 V, I _D = 12 A | | 0.009 0.011 | | 0 | | |
| | R _{DS(on)} | $V_{GS} = 6.0 \text{ V}, I_D = 10 \text{ A}$ | | 0.0105 | 0.013 | Ω | | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = 15 V, I _D = 10 A | | 50 | | S | | |
| Diode Forward Voltage ^a | V_{SD} | I _S = 3.0 A, V _{GS} = 0 V | | 0.75 | 1.2 | V | | |
| Dynamic ^b | | | | | | | | |
| Total Gate Charge | Q_g | | | 46 | 57 | | | |
| Gate-Source Charge | Q_{gs} | $V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 12 \text{ A}$ | | 11.5 | | nC | | |
| Gate-Drain Charge | Q_{gd} | | | 11.5 | | 1 | | |
| Gate Resistance | R_{g} | | 0.25 | 0.85 | 1.4 | Ω | | |
| Turn-On Delay Time | t _{d(on)} | | | 16 | 25 | | | |
| Rise Time | t _r | V_{DD} = 30 V, R_L = 30 Ω | | 12 | 18 | | | |
| Turn-Off Delay Time | t _{d(off)} | $I_D\cong$ 1.0 A, V_{GEN} = 10 V, R_g = 6 Ω | | 50 | 75 | ns | | |
| Fall Time | t _f | | | 30 | 45 | | | |
| Source-Drain Reverse Recovery Time | t _{rr} | $I_F = 3.0 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}$ | | 40 | 60 | | | |

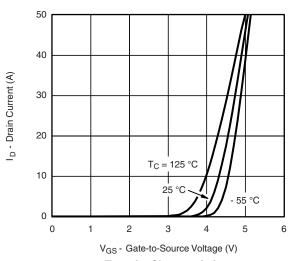
Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





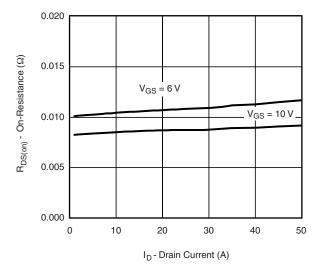
Transfer Characteristics



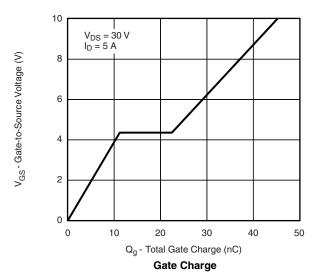


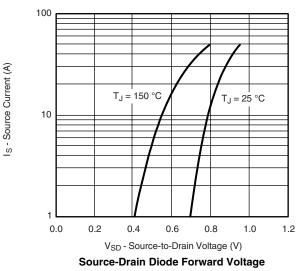


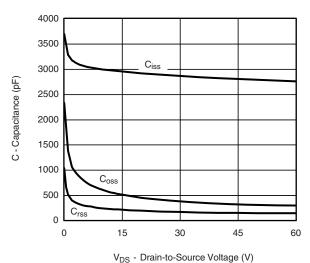
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On-Resistance vs. Drain Current

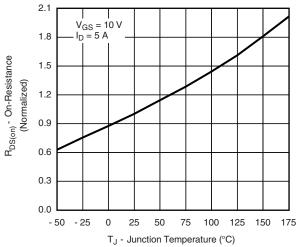




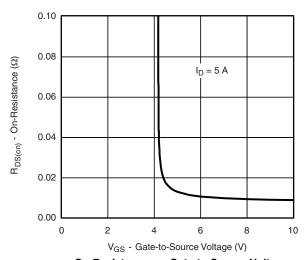


Consistence

Capacitance



On-Resistance vs. Junction Temperature

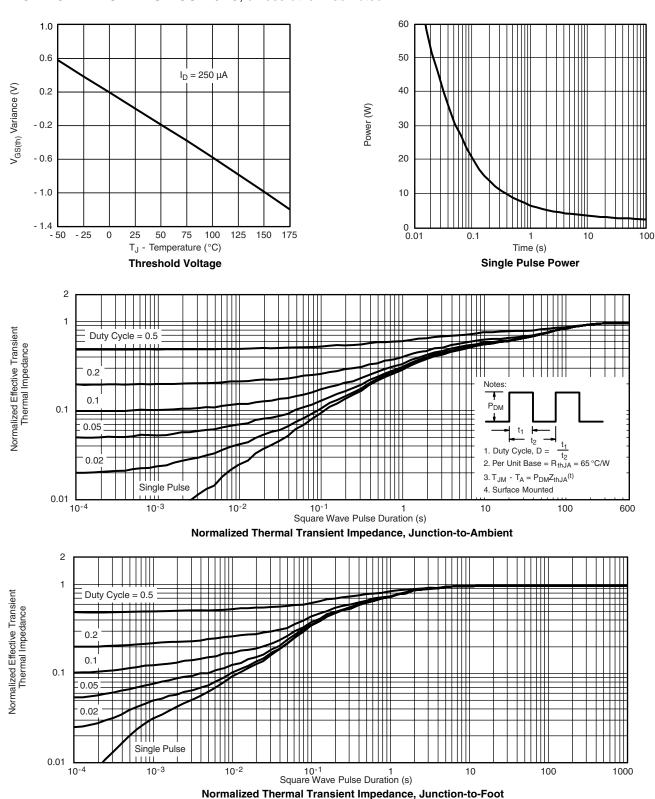


On-Resistance vs. Gate-to-Source Voltage

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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